

L Number	Hits	Search Text	DB	Time stamp
1	7068	guard near ring	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/30 17:43
2	3602422	trench recess groove opening	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/30 17:44
3	2682	(guard near ring) and (trench recess groove opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/30 17:44
4	1889912	substrate wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/30 17:44
5	1700	((guard near ring) and (trench recess groove opening)) and (substrate wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/30 17:45